

### GENERAL DESCRIPTION

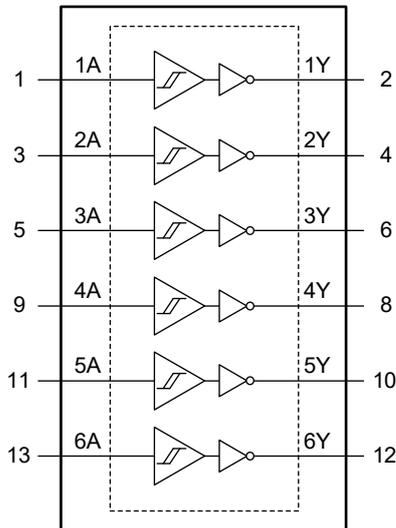
The 74AHC14Q is a hex inverter with Schmitt-Trigger inputs that is designed for 2.0V to 5.5V  $V_{CC}$  operation. The device implements the Boolean function  $Y = \bar{A}$ .

Each circuit can achieve the function of an independent inverter, but due to the influence of Schmitt-Trigger action, the inverters can provide different positive-going threshold voltage ( $V_{T+}$ ) and negative-going threshold voltage ( $V_{T-}$ ).

The device is AEC-Q100 qualified (Automotive Electronics Council (AEC) standard Q100 Grade 1) and it is suitable for automotive applications.

The 74AHC14Q is available in Green SOIC-14 and TSSOP-14 packages. It operates over an operating temperature range of  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

### LOGIC DIAGRAM



### FEATURES

- **AEC-Q100 Qualified for Automotive Applications Device Temperature Grade 1**  
 $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- **Wide Operating Voltage Range: 2.0V to 5.5V**
- **Inputs Accept Voltages Higher than the Supply Voltage and up to 5.5V**
- **+8mA/-8mA Output Current**
- **All Inputs with Schmitt-Trigger**
- **$-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  Operating Temperature Range**
- **Available in Green SOIC-14 and TSSOP-14 Packages**

### APPLICATIONS

- Automotive Applications
- Synchronize Inverted Clock Inputs
- Debounce Switches
- Invert Digital Signals

### FUNCTION TABLE

INPUT	OUTPUT
nA	nY
L	H
H	L

$Y = \bar{A}$

H = High Voltage Level

L = Low Voltage Level

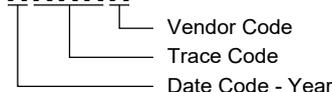
## PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE TOP MARKING	PACKING OPTION
74AHC14Q	SOIC-14	-40°C to +125°C	74AHC14QS14G/TR	16MS14 XXXXXX	Tape and Reel, 2500
	TSSOP-14	-40°C to +125°C	74AHC14QTS14G/TR	16H TS14 XXXXXX	Tape and Reel, 4000

## MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.

**XXXXX**



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage Range, $V_{CC}$ .....	-0.5V to 7.0V
Input Voltage Range, $V_I$ <sup>(1)</sup> .....	-0.5V to 7.0V
Output Voltage Range, $V_O$ <sup>(1)</sup> .....	-0.5V to MIN(7.0V, $V_{CC} + 0.5V$ )
Input Clamp Current, $I_{IK}$ ( $V_I < 0V$ ) .....	-20mA
Output Clamp Current, $I_{OK}$ ( $V_O < 0V$ or $V_O > V_{CC}$ ) .....	$\pm 20mA$
Continuous Output Current, $I_O$ ( $V_O = 0V$ to $V_{CC}$ ) .....	$\pm 25mA$
Continuous Current through $V_{CC}$ or GND .....	$\pm 50mA$
Junction Temperature <sup>(2)</sup> .....	+150°C
Storage Temperature Range .....	-65°C to +150°C
Lead Temperature (Soldering, 10s) .....	+260°C
ESD Susceptibility <sup>(3)(4)</sup> .....	
HBM .....	$\pm 4000V$
CDM .....	$\pm 1000V$

## NOTES:

1. The input and output voltage ratings may be exceeded if the input and output clamp current ratings are observed.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.
3. For human body model (HBM), all pins comply with AEC-Q100-002 specification.
4. For charged device model (CDM), all pins comply with AEC-Q100-011 specification.
5. Unused input pins must be held at  $V_{CC}$  or GND to guarantee the device in normal operation.

## RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range, $V_{CC}$ .....	2.0V to 5.5V
Input Voltage Range, $V_I$ <sup>(5)</sup> .....	0V to 5.5V
Output Voltage Range, $V_O$ .....	0V to $V_{CC}$
Output Current, $I_O$ .....	$\pm 8mA$
Operating Temperature Range .....	-40°C to +125°C

## OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

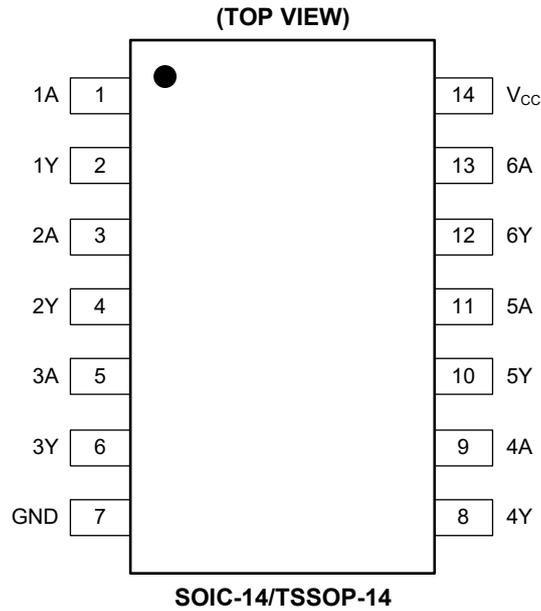
## ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

## DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

**PIN CONFIGURATIONS**



**PIN DESCRIPTION**

PIN	NAME	FUNCTION
1, 3, 5, 9, 11, 13	1A, 2A, 3A, 4A, 5A, 6A	Data Inputs.
2, 4, 6, 8, 10, 12	1Y, 2Y, 3Y, 4Y, 5Y, 6Y	Data Outputs.
7	GND	Ground.
14	V <sub>CC</sub>	Supply Voltage.

**ELECTRICAL CHARACTERISTICS**(Full = -40°C to +125°C, all typical values are measured at T<sub>A</sub> = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
High-Level Output Voltage	V <sub>OH</sub>	V <sub>CC</sub> = 2.0V, I <sub>OH</sub> = -50μA	Full	1.9	1.995		V
		V <sub>CC</sub> = 3.0V, I <sub>OH</sub> = -50μA	Full	2.9	2.995		
		V <sub>CC</sub> = 4.5V, I <sub>OH</sub> = -50μA	Full	4.4	4.495		
		V <sub>CC</sub> = 3.0V, I <sub>OH</sub> = -4mA	Full	2.6	2.850		
		V <sub>CC</sub> = 4.5V, I <sub>OH</sub> = -8mA	Full	4.0	4.250		
Low-Level Output Voltage	V <sub>OL</sub>	V <sub>CC</sub> = 2.0V, I <sub>OL</sub> = 50μA	Full		0.005	0.1	V
		V <sub>CC</sub> = 3.0V, I <sub>OL</sub> = 50μA	Full		0.005	0.1	
		V <sub>CC</sub> = 4.5V, I <sub>OL</sub> = 50μA	Full		0.005	0.1	
		V <sub>CC</sub> = 3.0V, I <sub>OL</sub> = 4mA	Full		0.15	0.4	
		V <sub>CC</sub> = 4.5V, I <sub>OL</sub> = 8mA	Full		0.25	0.5	
Input Leakage Current	I <sub>I</sub>	V <sub>CC</sub> = 0V to 5.5V, V <sub>I</sub> = 5.5V or GND	Full		±0.02	±1	μA
Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 5.5V, V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0A	Full		0.02	20	μA
Input Capacitance	C <sub>I</sub>	V <sub>CC</sub> = 5.0V, V <sub>I</sub> = V <sub>CC</sub> or GND	+25°C		4		pF

**DYNAMIC CHARACTERISTICS**(See Figure 1 for test circuit. Full = -40°C to +125°C, all typical values are measured at V<sub>CC</sub> = 3.3V and 5.0V respectively, T<sub>A</sub> = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN <sup>(1)</sup>	TYP	MAX <sup>(1)</sup>	UNITS	
Low-to-High Propagation Delay	t <sub>PLH</sub>	V <sub>CC</sub> = 3.3V ± 0.3V, see Figure 2	C <sub>L</sub> = 15pF	Full	0.5	4.4	8.7	ns
			C <sub>L</sub> = 50pF	Full	1.0	6.7	14.1	
		V <sub>CC</sub> = 5.0V ± 0.5V, see Figure 2	C <sub>L</sub> = 15pF	Full	0.5	3.2	6.0	
			C <sub>L</sub> = 50pF	Full	0.5	4.6	9.0	
High-to-Low Propagation Delay	t <sub>PHL</sub>	V <sub>CC</sub> = 3.3V ± 0.3V, see Figure 2	C <sub>L</sub> = 15pF	Full	0.5	4.1	8.1	ns
			C <sub>L</sub> = 50pF	Full	1.0	5.7	10.5	
		V <sub>CC</sub> = 5.0V ± 0.5V, see Figure 2	C <sub>L</sub> = 15pF	Full	0.5	3.1	5.7	
			C <sub>L</sub> = 50pF	Full	0.5	4.3	7.6	
Power Dissipation Capacitance <sup>(2)</sup>	C <sub>PD</sub>	V <sub>CC</sub> = 5.0V, no load, f <sub>i</sub> = 1MHz	+25°C		8		pF	

## NOTES:

- Specified by design and characterization, not production tested.
- C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$$

where:

f<sub>i</sub> = Input frequency in MHz.f<sub>o</sub> = Output frequency in MHz.C<sub>L</sub> = Output load capacitance in pF.V<sub>CC</sub> = Supply voltage in Volts.

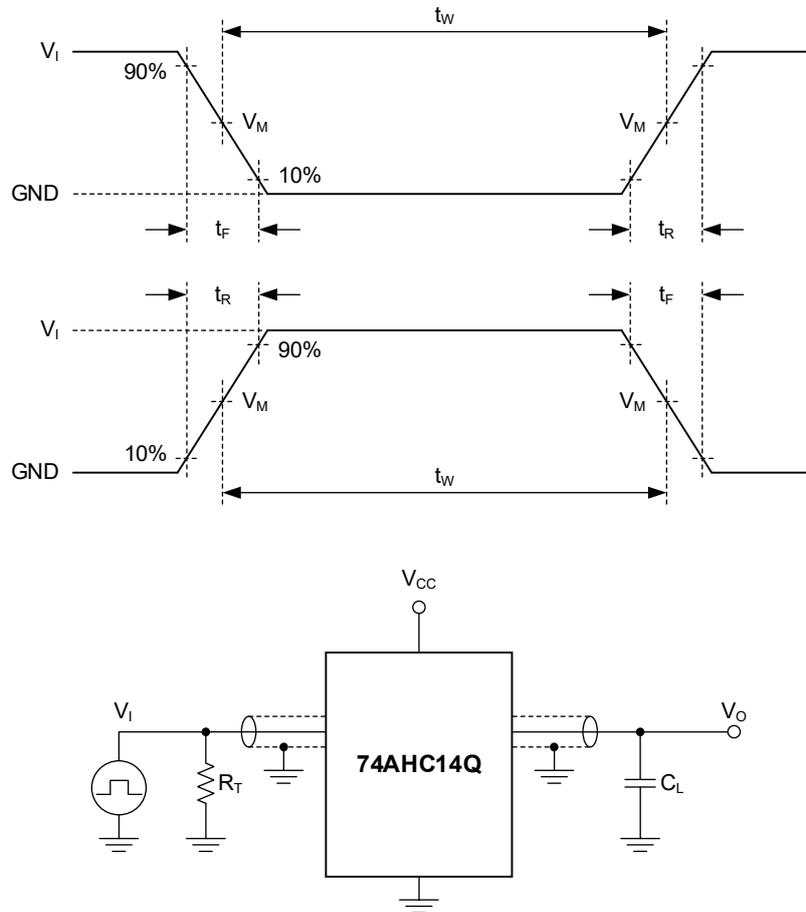
N = Number of inputs switching.

Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = Sum of the outputs.

**TRANSFER CHARACTERISTICS**(Full = -40°C to +125°C, all typical values are measured at  $T_A = +25^\circ\text{C}$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
Positive-Going Threshold Voltage	$V_{T+}$	$V_{CC} = 3.0\text{V}$	Full	1.20	1.85	2.20	V
		$V_{CC} = 4.5\text{V}$	Full	1.75	2.65	3.15	
		$V_{CC} = 5.5\text{V}$	Full	2.15	3.15	3.85	
Negative-Going Threshold Voltage	$V_{T-}$	$V_{CC} = 3.0\text{V}$	Full	0.90	1.25	1.90	V
		$V_{CC} = 4.5\text{V}$	Full	1.35	1.90	2.75	
		$V_{CC} = 5.5\text{V}$	Full	1.65	2.30	3.35	
Hysteresis Voltage	$V_H$	$V_{CC} = 3.0\text{V}$	Full	0.25	0.60	1.20	V
		$V_{CC} = 4.5\text{V}$	Full	0.35	0.75	1.40	
		$V_{CC} = 5.5\text{V}$	Full	0.45	0.85	1.60	

TEST CIRCUIT



Test conditions are given in Table 1.

Definitions for test circuit:

$C_L$ : Load capacitance (includes jig and probe).

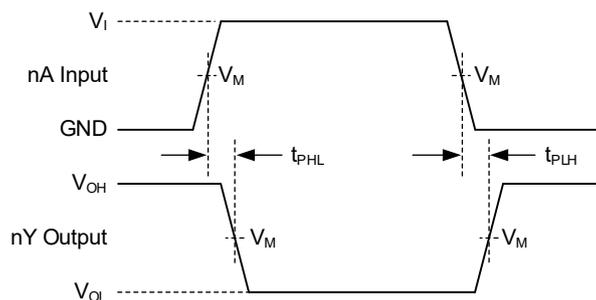
$R_T$ : Termination resistance (equals to output impedance  $Z_O$  of the pulse generator).

Figure 1. Test Circuit for Measuring Switching Times

Table 1. Test Conditions

SUPPLY VOLTAGE	INPUT		LOAD	TEST
$V_{CC}$	$V_I$	$t_R, t_F$	$C_L$	
2.0V to 5.5V	$V_{CC}$	$\leq 3.0ns$	15pF, 50pF	$t_{PHL}, t_{PLH}$

WAVEFORMS



Test conditions are given in Table 1.

Measurement points are given in Table 2.

$V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Figure 2. Input (nA) to Output (nY) Propagation Delay Times

Table 2. Measurement Points

SUPPLY VOLTAGE	INPUT		OUTPUT
$V_{CC}$	$V_I$	$V_M^{(1)}$	$V_M$
2.0V to 5.5V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$

NOTE:

1. The measurement points should be  $V_{IH}$  or  $V_{IL}$  when the input rising or falling time exceeds 3.0ns.

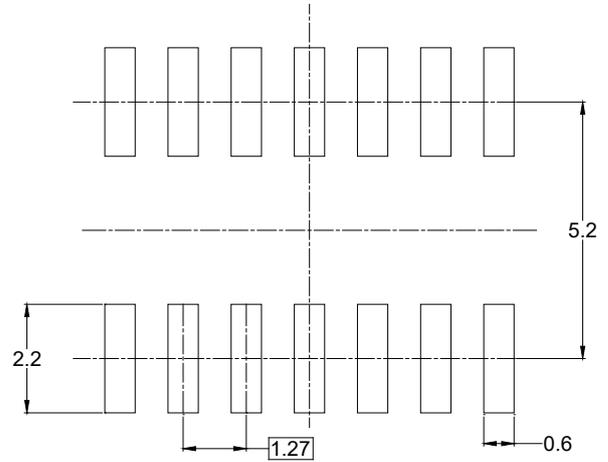
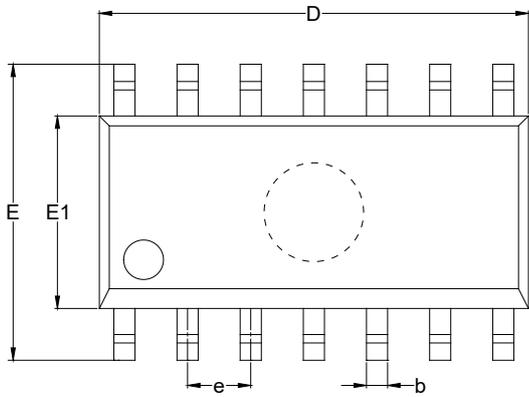
REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

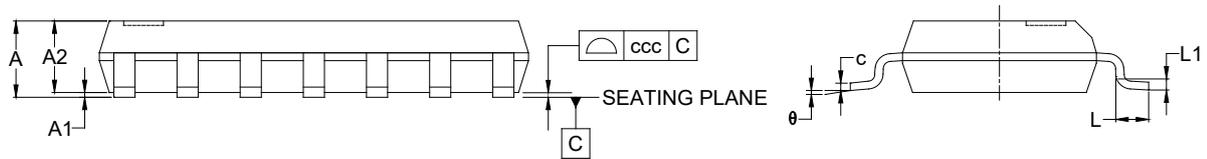
Changes from Original (DECEMBER 2024) to REV.A	Page
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PACKAGE OUTLINE DIMENSIONS

SOIC-14



RECOMMENDED LAND PATTERN (Unit: mm)



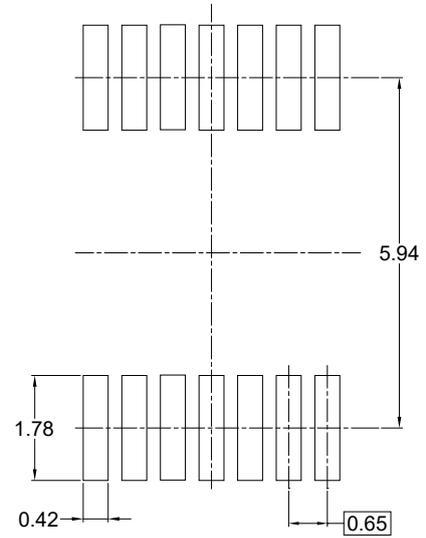
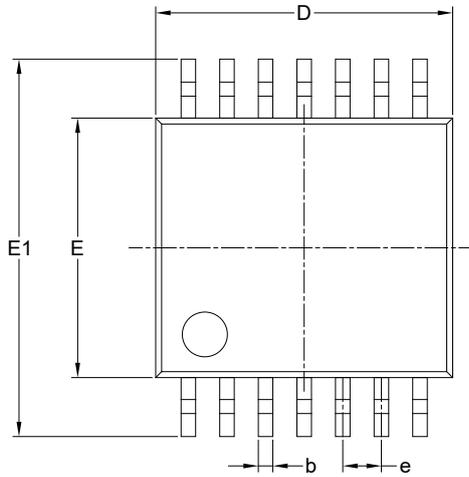
Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.750
A1	0.100	-	0.250
A2	1.250	-	-
b	0.310	-	0.510
c	0.100	-	0.250
D	8.450	-	8.850
E	5.800	-	6.200
E1	3.800	-	4.000
e	1.270 BSC		
L	0.400	-	1.270
L1	0.250 TYP		
$\theta$	0°	-	8°
ccc	0.100		

NOTES:

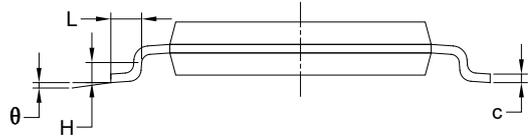
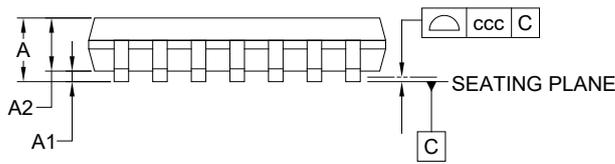
1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MS-012.

PACKAGE OUTLINE DIMENSIONS

TSSOP-14



RECOMMENDED LAND PATTERN (Unit: mm)



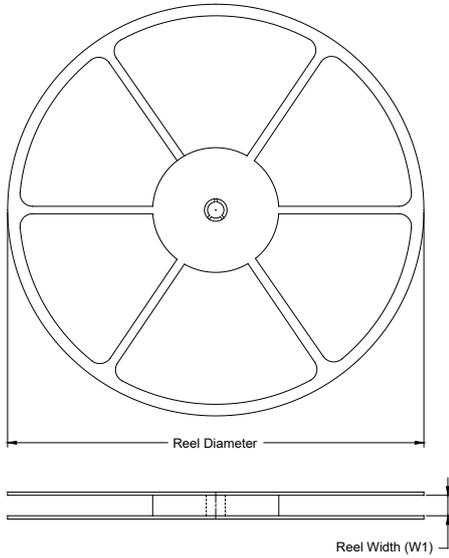
Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.200
A1	0.050	-	0.150
A2	0.800	-	1.050
b	0.190	-	0.300
c	0.090	-	0.200
D	4.860	-	5.100
E	4.300	-	4.500
E1	6.200	-	6.600
e	0.650 BSC		
L	0.450	-	0.750
H	0.250 TYP		
theta	0°	-	8°
ccc	0.100		

NOTES:

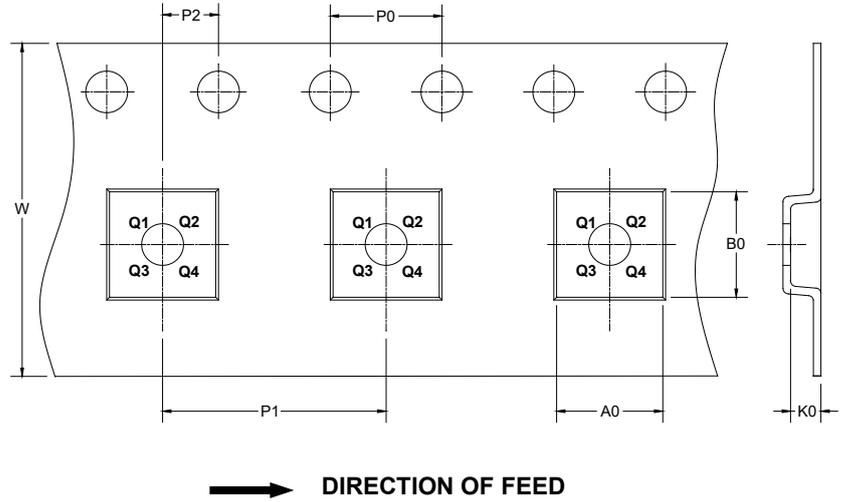
1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-153.

**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**



**TAPE DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

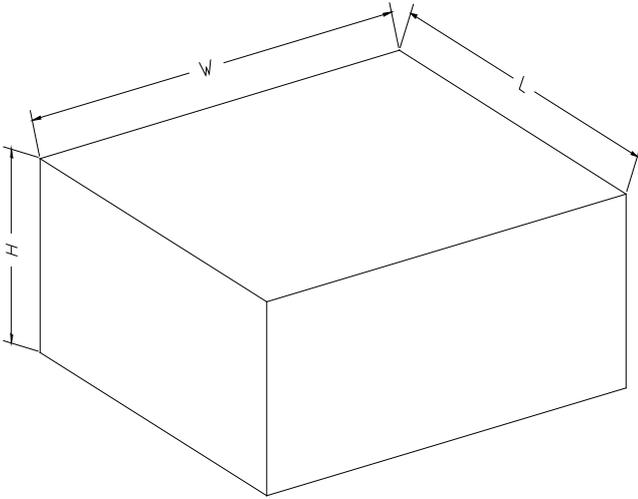
**KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-14	13"	16.4	6.60	9.30	2.10	4.0	8.0	2.0	16.0	Q1
TSSOP-14	13"	12.4	6.80	5.40	1.50	4.0	8.0	2.0	12.0	Q1

D20001

# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002